

# FCU850N80Z Datasheet



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DiGi Electronics Part Number FCU850N80Z-DG

Manufacturer onsemi

Manufacturer Product Number FCU850N80Z

Description MOSFET N-CH 800V 6A IPAK

Detailed Description N-Channel 800 V 6A (Tc) 75W (Tc) Through Hole I-P

AK



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# **Purchase and inquiry**

Manufacturer Product Number:	Manufacturer:
FCU850N80Z	onsemi
Series:	Product Status:
SuperFET® II	Obsolete
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
800 V	6A (Tc)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ ld, Vgs:
10V	850mOhm @ 3A, 10V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
4.5V @ 600μA	29 nC @ 10 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±20V	1315 pF @ 100 V
FET Feature:	Power Dissipation (Max):
	75W (Tc)
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Through Hole
Supplier Device Package:	Package / Case:
I-PAK	TO-251-3 Short Leads, IPak, TO-251AA
Base Product Number:	
FCU850	

# **Environmental & Export classification**

8541.29.0095

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	Not Applicable
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	



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October 2014

# FCD850N80Z / FCU850N80Z N-Channel SuperFET® II MOSFET

**800 V, 6 A, 850 m**Ω

### **Features**

- Typ.  $R_{DS(on)} = 710 \text{ m}\Omega \text{ (Typ.)}$
- Ultra Low Gate Charge (Typ. Q<sub>g</sub> = 22 nC)
- Low E<sub>oss</sub> (Typ. 2.3 uJ @ 400V)
- Low Effective Output Capacitance (Typ. Coss(eff.) = 106 pF)
- 100% Avalanche Tested
- RoHS Compliant
- · ESD Improved Capability

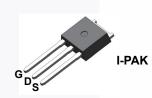
#### **Applications**

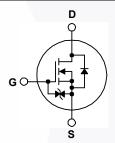
- · AC DC Power Supply
- · LED Lighting

## **Description**

SuperFET® II MOSFET is Fairchild Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. In addition, internal gate-source ESD diode allows to withstand over 2kV HBM surge stress.Consequently, SuperFET II MOSFET is very suitable for the switching power applications such as Audio, Laptop adapter, Lighting, ATX power and industrial power applications.







# $\textbf{Absolute Maximum Ratings} \ \texttt{T}_{\texttt{C}} = 25^{o} \texttt{Cunless otherwise noted}.$

Symbol	Parameter			FCD850N80Z FCU850N80Z	Unit
V <sub>DSS</sub>	Drain to Source Voltage			800	V
V	Gate to Source Voltage	- DC	- DC		V
$V_{GSS}$	Gate to Source voltage	- AC	(f > 1 Hz)	±30	V
	Drain Current	- Continuous (T <sub>C</sub> = 25°C)		6	Α
I <sub>D</sub>		- Continuous (T <sub>C</sub> = 100°C)		3.8	
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	18	Α
E <sub>AS</sub>	Single Pulsed Avalanche Energy	/	(Note 2)	114	mJ
I <sub>AR</sub>	Avalanche Current		(Note 1)	1.2	Α
E <sub>AR</sub>	Repetitive Avalanche Energy		(Note 1)	0.284	mJ
dv/dt	MOSFET dv/dt			100	V/ns
αν/αι	Peak Diode Recovery dv/dt		(Note 3)	20	V/IIS
D	Dower Dissipation	(T <sub>C</sub> = 25°C)		75	W
$P_{D}$	Power Dissipation	- Derate Above 25°C		0.6	W/°C
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Tempera	Operating and Storage Temperature Range			°C
TL	Maximum Lead Temperature for	Soldering, 1/8" from Case for 5 S	econds	300	οС

#### **Thermal Characteristics**

Symbol	Parameter	FCD850N80Z FCU850N80Z	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	1.65	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max.	100	*C/VV

# **Package Marking and Ordering Information**

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FCD850N80Z	FCD850N80Z	DPAK	Tape and Reel	330 mm	16 mm	2500 units
FCU850N80Z	FCU850N80Z	IPAK	Tube	NA	NA	75 units

## **Electrical Characteristics** T<sub>C</sub> = 25°C unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA, T <sub>J</sub> = 25°C	800	-	-	V
ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 1 mA, Referenced to 25°C	-	0.8	-	V/°C
1	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 800 V, V <sub>GS</sub> = 0 V	-	-	25	μА
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 640 \text{ V}, V_{GS} = 0 \text{ V}, T_{C} = 125^{\circ}\text{C}$	-	-	250	μΑ
$I_{GSS}$	Gate to Body Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	±10	μΑ

#### **On Characteristics**

V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS} = V_{DS}$ , $I_D = 0.6$ mA	2.5	-	4.5	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, I_D = 3 \text{ A}$	-	710	850	$m\Omega$
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 20 \text{ V}, I_{D} = 3 \text{ A}$	-	3.5	-	S

#### **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	V 400 V V 0 V	-\	990	1315	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V, f = 1 MHz	- \	28	37	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	-	-	0.74	-	pF
C <sub>oss</sub>	Output Capacitance	$V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	15	-	pF
C <sub>oss(eff.)</sub>	Effective Output Capacitance	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$	-	106	-	pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10V	V <sub>DS</sub> = 640 V, I <sub>D</sub> = 6 A,	-	22	29	nC
$Q_{gs}$	Gate to Source Gate Charge	V <sub>GS</sub> = 10 V	-	5	-	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge	(Note 4)	-	8.6	-	nC
ESR	Equivalent Series Resistance	f = 1 MHz	-	2.4	-	Ω

#### **Switching Characteristics**

t <sub>d(on)</sub>	Turn-On Delay Time		- /	16	42	ns
t <sub>r</sub>	Turn-On Rise Time	$V_{DD} = 400 \text{ V}, I_D = 6 \text{ A},$	-/	10	30	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, R_g = 4.7 \Omega$	-	40	90	ns
t <sub>f</sub>	Turn-Off Fall Time	(Note 4)	_	4.5	19	ns

#### **Drain-Source Diode Characteristics**

I <sub>S</sub>	Maximum Continuous Drain to Source Diode Forward Current		-	-	6	Α
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Forward Current		-	-	18	Α
$V_{SD}$	Drain to Source Diode Forward Voltage   V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 6 A		-	-	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0 V, I <sub>SD</sub> = 6 A,	-	318	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	$dI_F/dt = 100 A/\mu s$	-	4.5	-	μС

#### Notes:

- 1. Repetitive rating: pulse width limited by maximum junction temperature.
- 2.  $I_{AS}$  = 1.2 A,  $V_{DD}$  = 50 V,  $R_G$  = 25  $\Omega$ , Starting  $T_J$  = 25°C
- 3. I $_{SD}$   $\leq$  6 A, di/dt  $\leq$  200 A/ $\mu$ s, V $_{DD}$   $\leq$  BV $_{DSS}$ , Starting T $_{J}$  = 25°C
- 4. Essentially independent of operating temperature typical characteristics.

### **Typical Performance Characteristics**

Figure 1. On-Region Characteristics

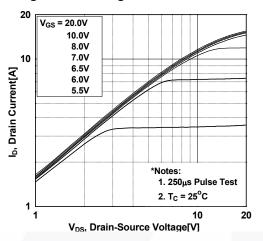


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

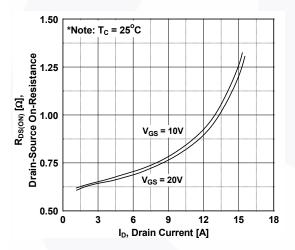


Figure 5. Capacitance Characteristics

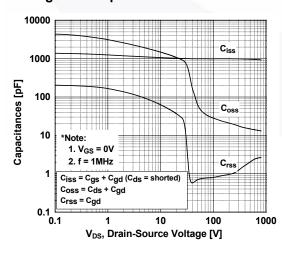


Figure 2. Transfer Characteristics

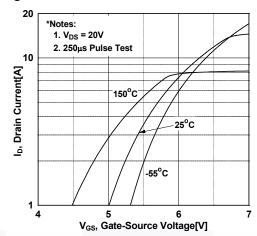


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

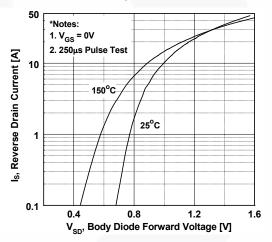
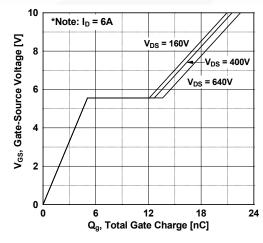


Figure 6. Gate Charge Characteristics



## **Typical Performance Characteristics** (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

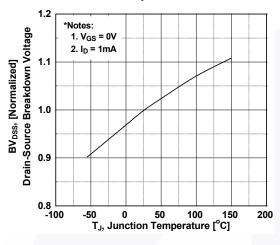


Figure 9. Maximum Safe Operating Area

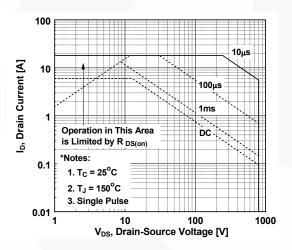


Figure 11. Eoss vs. Drain to Source Voltage

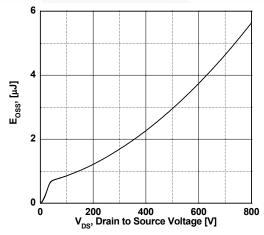


Figure 8. On-Resistance Variation vs. Temperature

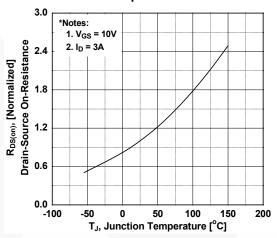
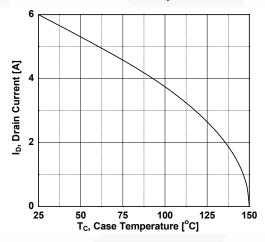
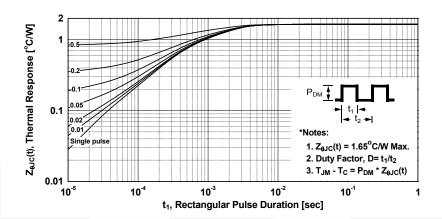


Figure 10. Maximum Drain Current vs. Case Temperature



# **Typical Performance Characteristics** (Continued)

Figure 12. Transient Thermal Response Curve



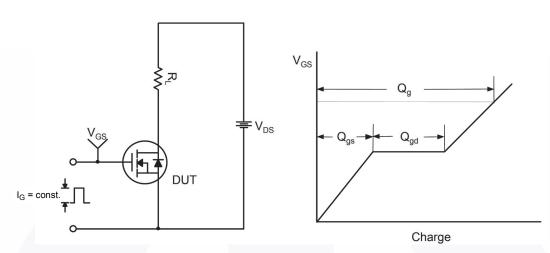


Figure 13. Gate Charge Test Circuit & Waveform

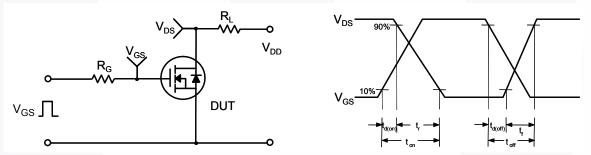


Figure 14. Resistive Switching Test Circuit & Waveforms

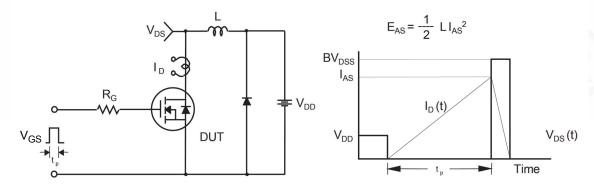


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

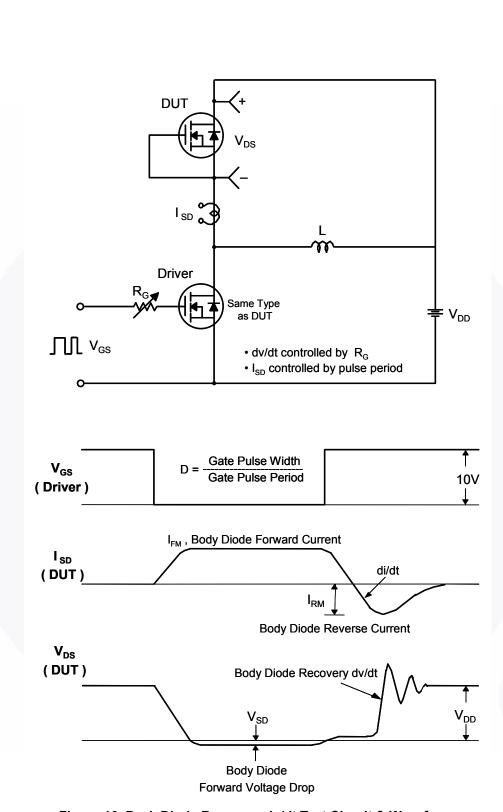
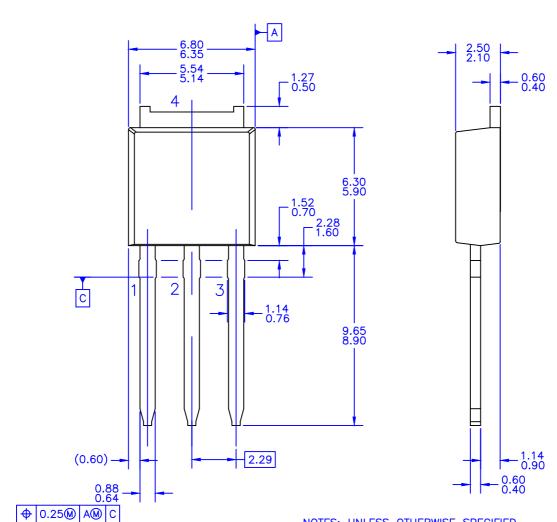
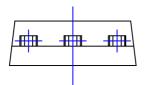


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms



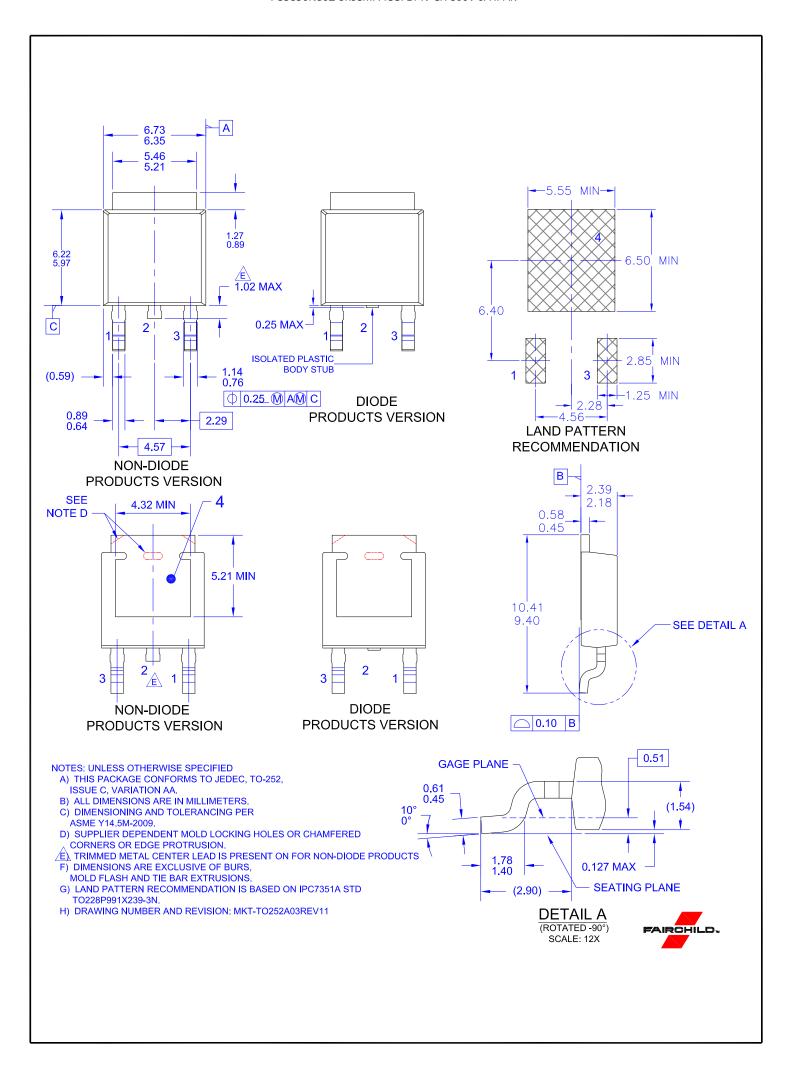


3 PLCS

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  - DRAWING NUMBER AND REVISION: MKT-T0251A03REV2 D)





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